

YANG Data Models for TE and RSVP

`draft-ietf-teas-yang-te-03`

`draft-ietf-teas-yang-rsvp-03`

<https://github.com/ietf-mpls-yang/te>

Tarek Saad (Presenter) and Rakesh Gandhi, Cisco Systems

Vishnu Pavan Beeram, Juniper Networks

Xufeng Liu, Ericsson

Himanshu Shah, Ciena

Xia Chen, Huawei Technologies

Raqib Jones, Brocade

Bin Wen, Comcast

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Agenda

- Updates (from previous version)
- Open issues
- Next steps

Update # 1

Regrouping of TE generic model

- Issue - TE generic model need to contain no device specific data
 - The TE generic model may be deployed to model data outside the scope of a device (e.g. TE SDN controller, PCE)
 - TE generic model covers data
 - Global scoped: e.g. tunnels, LSPs
 - Device scoped: e.g. TE interfaces properties, device timers, device local policies, etc.
 - Ideally maximize reusability of existing TE generic model
- Resolution -
 - Regroup and extract device-specific data into separate module that augments the TE generic model

TE device data YANG model

```

module: ietf-te-device
augment /ietf-te:te:
  +-rw interfaces
    +-rw config
      |  +-rw flood-thresholds
      +-rw interface* [interface]
        +-rw interface if:interface-ref
        +-rw config
          |  +-rw te-metric?
          |  +-rw (admin-group-type)?
          |  |  +--:(value-admin-groups)
...
          |  |  +--:(named-admin-groups)
          |  +-rw (srlg-type)?
          |  |  +--:(value-srlgs)
...
          |  |  +--:(named-srlgs)
...
  +-ro te-advertisements_state
    +-ro flood-interval?
    +-ro last-flooded-time?
    +-ro next-flooded-time?
    +-ro last-flooded-trigger?
    +-ro advertized-level-areas*
      +-ro level-area uint32

```

```

module: ietf-te-device
augment /ietf-te:te/ietf-te:globals/ietf-te:config:
  +-rw lsp-install-interval? uint32
  +-rw lsp-cleanup-interval? uint32
augment /ietf-te:te/ietf-te:globals/ietf-te:state:
  +-ro lsp-install-interval? uint32
  +-ro lsp-cleanup-interval? uint32
  +-ro tunnels-counter? uint32
  +-ro lspbs-counter? uint32
augment /ietf-te:te/ietf-te:lspbs-state/ietf-te:lsp:
  +-ro lsp-timers
    |  +-ro life-time? uint32
    |  +-ro time-to-install? uint32
    |  +-ro time-to-die? uint32
  +-ro downstream-info
    |  +-ro nhop? inet:ip-address
    |  +-ro outgoing-interface? if:interface-ref
    |  +-ro neighbor? inet:ip-address
    |  +-ro label? uint32
  +-ro upstream-info
    +-ro phop? inet:ip-address
    +-ro neighbor? inet:ip-address
    +-ro label? uint32

```

Update # 2

Reuse of TE model for different TE technologies

- Issue – Reuse of the TE model for multiple technologies
 - TE model defined at the root TOP
 - Natural way for technology specific data to reside below the technology, e.g. .../mpls/te/.., or .../otn/te/... etc.
 - Reuse the same TE model and only augment with specific technology data (if needed)
 - YANG language currently does not allow attaching same YANG model in multiple places of the YANG tree
- Resolution - OPEN
 - Several proposals to extend this capability to YANG, e.g. using “mounts”

Update # 3

General edits to TE/RSVP data models

- **Issue** – Need to reflect the actual LSP path independent of the signaling protocol (e.g. RSVP-TE)
 - though present in the RSVP-TE model, some applications (e.g. controller) may use other signaling protocols to establish LSP
- Resolution - Add RECORD-ROUTE list in TE generic LSP state data
- **Issue** – Support for tunnel termination point identification
 - LSPs endpoint identified by destination node-identifier (or router ID) or TE interface
 - For some TE technologies LSPs originate/terminate on a specific port within a node – identified by termination point ID
 - Further discussion in update for “draft-ietf-teas-yang-te-topo”
- Resolution – Added source/destination Tunnel Termination Point identifier in TE general model

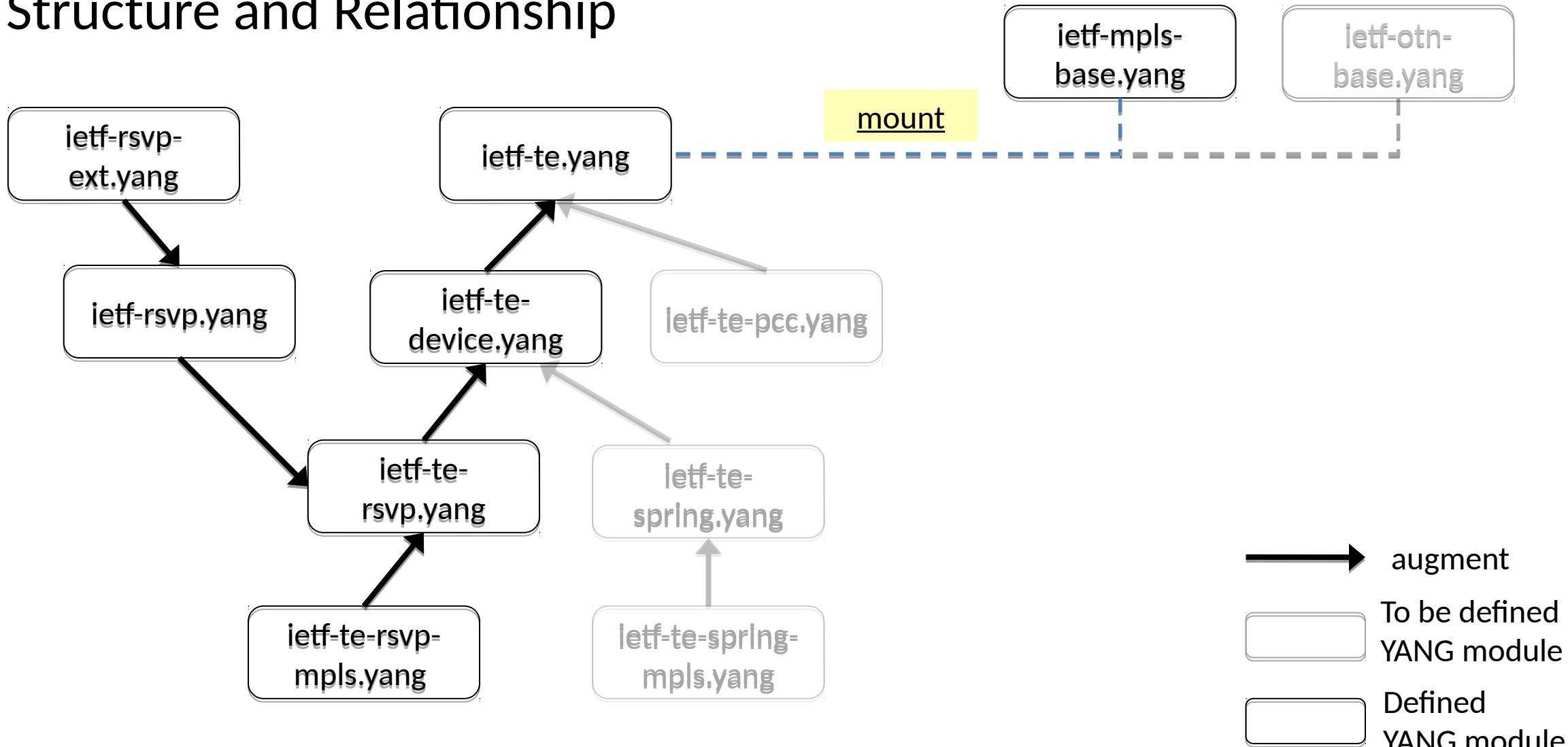
Update # 4

Minor edits/changes

- Added new module `ietf-te-mpls.yang`
 - Contains packet/mpls TE data
- Renamed “psc” to “mpls” in module names and data node names
 - PSC may (for some) be confused with other acronyms
 - More consistent with other mpls technology protocols (e.g. LDP and SR mpls)

TE/RSPV and MPLS YANG Modules

Structure and Relationship



Open Issues

1. Close on mechanism to mount the TE generic model for specific technology
 - May require adding new target “mount” node(s) in each technology module that TE generic model hangs from
2. Issue: schema-mount does not allow referencing outside the “mount” sandbox
 - Some leafrefs in the TE generic model referencing the global tree (e.g. interface list in interface module)

Next Steps

- Request further review and address comments
- Conclude on open issues
- Complete the augmenting modules for:
 1. PCC-TE data
 2. SR-TE data

Thank You